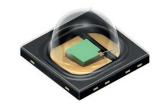
SFH 4736

OSLON® Black

IR Broadband Emitter - 80°





Applications

Infrared Spectroscopy

Features:

- Package: clear silicone
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Spectral range of emission: (typ) 650 ... 1050 nm
- Radiant intensity ($\lambda = 600 1050 \text{ nm}$): typ. 11 mW/sr
- Viewing angle of 80°
- Low thermal resistance (Max. 9 K/W)

Ordering Information

| Туре | Total radiant flux 1) typ. | Ordering Code |
|----------|--|---------------|
| | $I_{\rm F}$ = 350 mA; λ = 600 nm - 1050 nm; $t_{\rm p}$ = 20 ms $\Phi_{\rm e}$ | |
| SFH 4736 | 23 mW | O65112A0833 |



Maximum Ratings

| $T_{\scriptscriptstyle \wedge}$ | = | 25 | $^{\circ}C$ |
|---------------------------------|---|----|-------------|
| | | | |

| Parameter | Symbol | | Values |
|---|------------------|------|---------|
| Operating temperature | T _{op} | min. | -40 °C |
| | σp | max. | 85 °C |
| Storage temperature | T _{stg} | min. | -40 °C |
| | Sig | max. | 85 °C |
| Junction temperature | T _j | max. | 125 °C |
| Forward current | I _F | max. | 500 mA |
| Surge current | I _{FSM} | max. | 1 A |
| $t_{p} \le 1 \text{ ms; } D = 0$ | | | |
| Reverse current ²⁾ | I _R | max. | 200 mA |
| Power consumption | P _{tot} | max. | 1900 mW |
| ESD withstand voltage | V _{ESD} | max. | 2 kV |
| acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2) | 200 | | |

For the forward current and power consumption please see "maximum permissible forward current" diagram



Characteristics

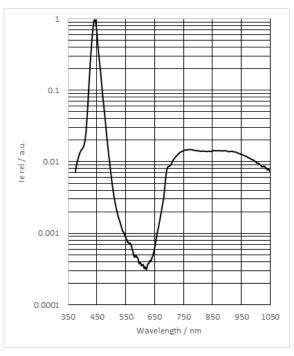
 $I_F = 350 \text{ mA}; t_p = 20 \text{ ms}; T_A = 25 \text{ }^{\circ}\text{C}$

| Parameter | Symbol | | Values |
|--|---|------------------------------------|--|
| Half angle | φ | typ. | 40 ° |
| Dimensions of active chip area | LxW | typ. | 1 x 1 mm x mm |
| Forward voltage 3) | V _F | typ. max. | 2.95 V 3.5 V |
| Forward voltage $^{3)}$ I _F = 500 mA; t _p = 100 µs | V _F | typ. max. | 3 V 3.8 V |
| Reverse voltage ²⁾ I _R = 20 mA | V_R | max. | 1.2 V |
| Reverse voltage (ESD device) 2) | V _{R ESD} | min. | 45 V |
| Radiant intensity $^{4)}$ $\lambda = 350 - 600 \text{ nm}$ | l _e | typ. | 60 mW/sr |
| Radiant intensity $^{4)}$ $\lambda = 600 - 1050 \text{ nm}$ | l _e | typ. | 11 mW/sr |
| Radiant intensity $^{4)}$ I _F = 500 mA; t _o = 10 ms; f = 0 MHz; λ = 350 - 600 nm | l _e | typ. | 85 mW/sr |
| Radiant intensity $^{4)}$ I _F = 500 mA; t _p = 10 ms; f = 0 MHz; λ = 600 - 1050 nm | l _e | typ. | 14 mW/sr |
| Total radiant flux ¹⁾ $\lambda = 350 - 600 \text{ nm}$ | Фе | typ. | 120 mW |
| Total radiant flux ¹⁾ $\lambda = 600 - 1050 \text{ nm}$ | Фе | typ. | 23 mW |
| Total radiant flux ¹⁾ $I_F = 500 \text{ mA}$; $t_D = 10 \text{ ms}$; $f = 0 \text{ MHz}$; $\lambda = 350 - 600 \text{ nm}$ | Фе | typ. | 160 mW |
| Total radiant flux ¹⁾ $I_F = 500 \text{ mA}$; $t_p = 10 \text{ ms}$; $f = 0 \text{ MHz}$; $\lambda = 600 - 1050 \text{ nm}$ | Фе | typ. | 29 mW |
| Spectral flux $\lambda = 750 \text{ nm}$ | $\boldsymbol{\varphi}_{\text{e},\lambda}$ | typ. | 65 μW/nm |
| Spectral flux λ = 850 nm | $\boldsymbol{\Phi}_{\text{e},\lambda}$ | typ. | 63 μW/nm |
| Spectral flux λ = 950 nm | $\boldsymbol{\Phi}_{\text{e},\lambda}$ | typ. | 60 μW/nm |
| Thermal resistance junction solder point real 5) | $R_{thJSreal}$ | max. | 9.0 K / W |
| $I_{F} = 500 \text{ mA; } t_{p} = 10 \text{ ms; } f = 0 \text{ MHz; } \lambda = 600 - 1050 \text{ nm}$ $Total \text{ radiant flux }^{1}$ $\lambda = 350 - 600 \text{ nm}$ $Total \text{ radiant flux }^{1}$ $\lambda = 600 - 1050 \text{ nm}$ $Total \text{ radiant flux }^{1}$ $I_{F} = 500 \text{ mA; } t_{p} = 10 \text{ ms; } f = 0 \text{ MHz; } \lambda = 350 - 600 \text{ nm}$ $Total \text{ radiant flux }^{1}$ $I_{F} = 500 \text{ mA; } t_{p} = 10 \text{ ms; } f = 0 \text{ MHz; } \lambda = 600 - 1050 \text{ nm}$ $Spectral \text{ flux } \lambda = 750 \text{ nm}$ $Spectral \text{ flux } \lambda = 850 \text{ nm}$ $Spectral \text{ flux } \lambda = 950 \text{ nm}$ | Ф _е Ф _е Ф _е Ф _{е,λ} | typ. typ. typ. typ. typ. typ. typ. | 120 23 160 29 65 µ\ 63 µ\ |



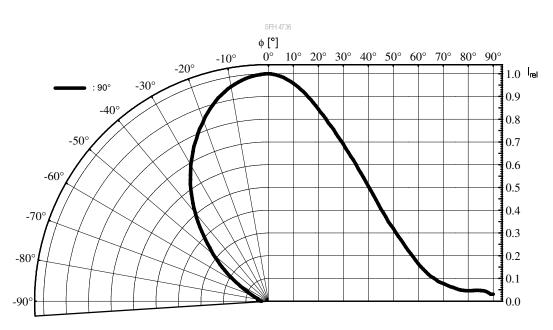
Relative Spectral Emission 6), 7)

 $I_{e,rel} = f(\lambda); I_{F} = 350 \text{ mA}; t_{p} = 20 \text{ ms}$



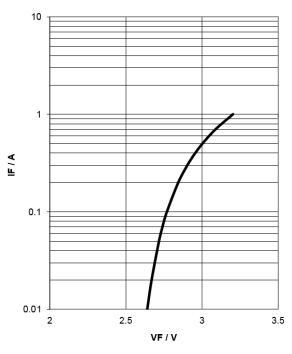
Radiation Characteristics 6), 7)

 $I_{e,rel} = f(\phi)$



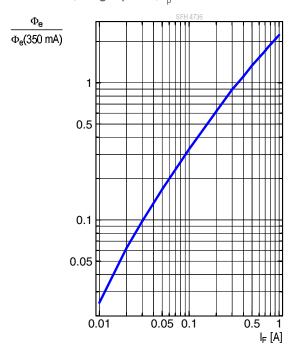
Forward current 6), 7)

 $I_F = f(V_F)$; single pulse; $t_p = 100 \mu s$



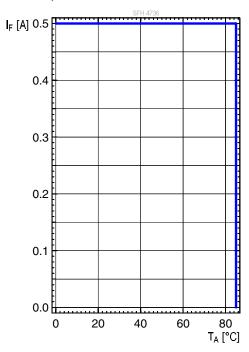
Relative Total Radiant Flux 6), 7)

 $\Phi_{\rm e}/\Phi_{\rm e}(350{\rm mA})$ = f (I_F); λ = 600 nm - 1050 nm; single pulse; t_p = 20 ms



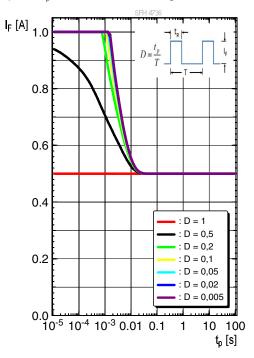
Max. Permissible Forward Current

$$I_{F,max} = f(T_S)$$
; Rth_{js} = 9K / W; single pulse

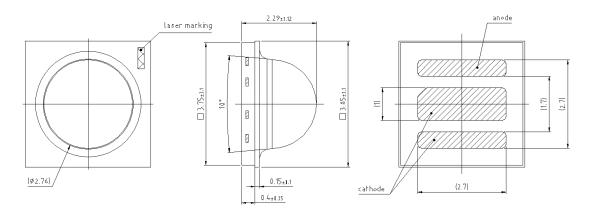


Permissible Pulse Handling Capability

$$I_F = f(t_p)$$
; D = parameter; $T_S = 85$ °C



Dimensional Drawing 8)



general tolerance ± 0.1

(63062-A4068-A10-02

Further Information:

Approximate Weight: 32.0 mg

Package marking: Anode

Corrosion test: Class: 3B

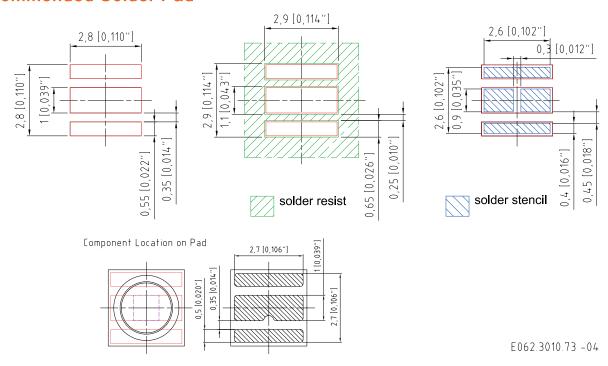
Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the

Chip.

Recommended Solder Pad 8)

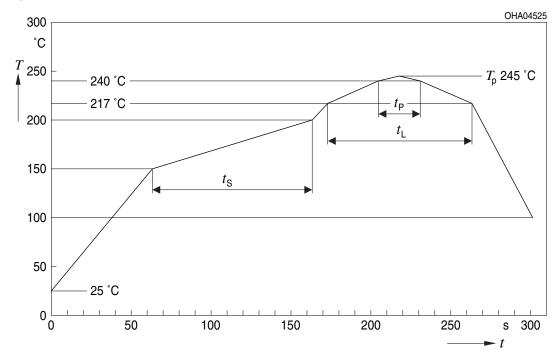


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



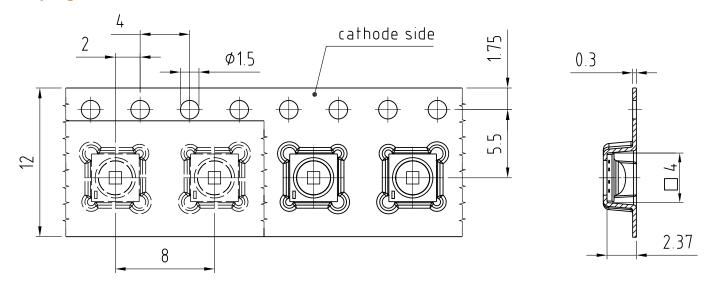
| Profile Feature | Symbol | Pb | Pb-Free (SnAgCu) Assembly | | |
|---|----------------|---------|---------------------------|---------|-----|
| | | Minimum | Recommendation | Maximum | |
| Ramp-up rate to preheat*) 25 °C to 150 °C | | | 2 | 3 | K/s |
| Time t _s T _{Smin} to T _{Smax} | t _s | 60 | 100 | 120 | S |
| Ramp-up rate to peak $^{*)}$ T _{Smax} to T _P | | | 2 | 3 | K/s |
| Liquidus temperature | T_{L} | | 217 | | °C |
| Time above liquidus temperature | t _L | | 80 | 100 | S |
| Peak temperature | T _P | | 245 | 260 | °C |
| Time within 5 °C of the specified peak temperature T _P - 5 K | t _P | 10 | 20 | 30 | S |
| Ramp-down rate* T _P to 100 °C | | | 3 | 6 | K/s |
| Time 25 °C to T _P | | | | 480 | S |

All temperatures refer to the center of the package, measured on the top of the component



^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

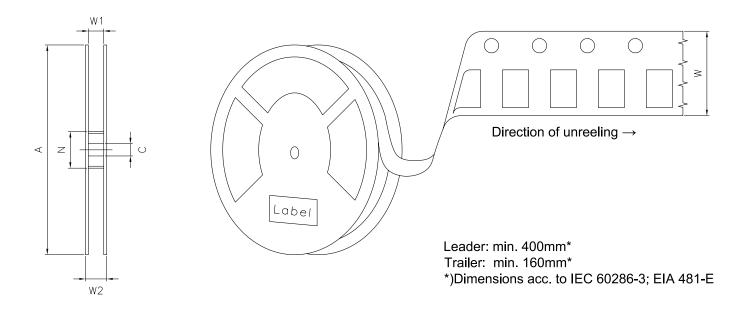
Taping 8)



C63062-A4068-B16-01



Tape and Reel 9)

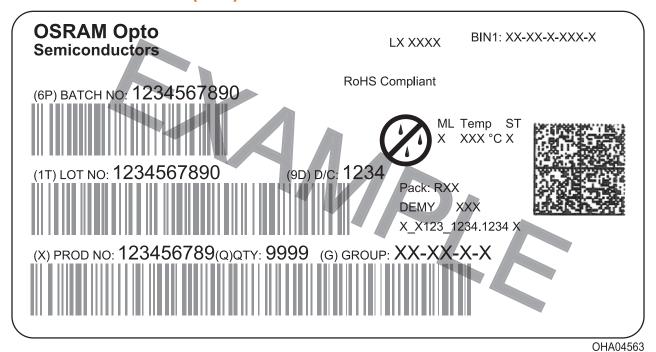


Reel Dimensions

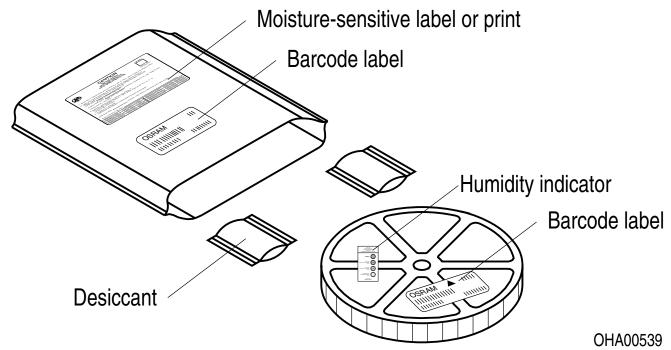
| Α | W | N_{\min} | W_1 | $W_{2 \text{ max}}$ | Pieces per PU |
|--------|--------------------|------------|------------|---------------------|---------------|
| 180 mm | 8 + 0.3 / - 0.1 mm | 60 mm | 8.4 + 2 mm | 14.4 mm | 600 |



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

OSRAM OS assumes no liability whatsoever for any use of this document or its content by recipient including, but not limited to, for any design in activities based on this preliminary draft version. OSRAM OS may e.g. decide at its sole discretion to stop developing and/or finalising the underlying design at any time.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- Total radiant flux: Measured with integrating sphere.
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Forward Voltage: The forward voltages are measured with a tolerance of ±0.1 V.
- ⁴⁾ **Radiant intensity:** Measured at a solid angle of Ω = 0.01 sr
- Thermal resistance: junction soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁷⁾ **Testing temperature:** TA = 25°C (unless otherwise specified)
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁹⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



| Revision History | | | | |
|------------------|------------|---|--|--|
| Version | Date | Change | | |
| 0.0 | 2018-12-12 | Additional Information | | |
| 0.1 | 2020-08-26 | Schematic Transportation Box Dimensions of Transportation Box | | |
| 0.2 | 2020-10-15 | Discontinued | | |



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准,不含有毒有害物质或元素。





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ams OSRAM:

SFH 4736